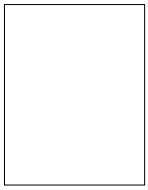
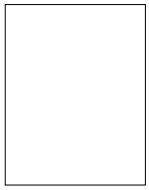
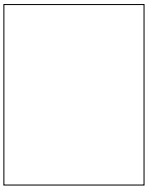


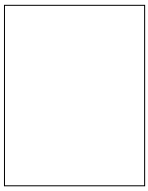
Programme Support
Pierre Plaza



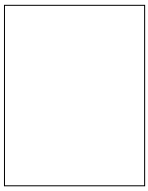
Americas' Representative
Tony Ambler



Eastern Europe Representative
Marta Rencz



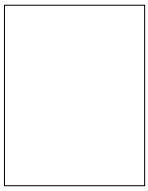
General Chair Support
Kees Schot



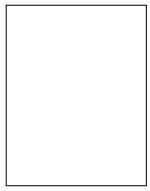
Asian Representative
Takayuki Yanagawa

Russian Liaison
Alexander Stempkovsky

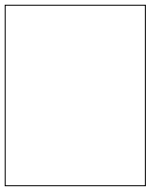
Programme Topic Co-Chairs



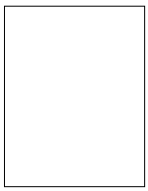
System Design
Wolfram Glauert



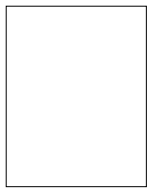
System Design
Flavio Wagner



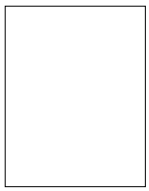
Embedded Systems
Jean-Paul Calvez



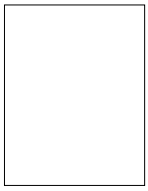
Embedded Systems
Nikil Dutt



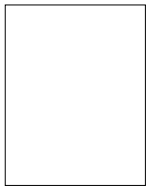
HW/SW Co-Design
Klaus Buchenrieder
(with Rolf Ernst)



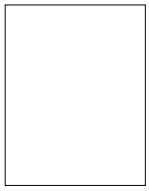
Microsystems
Klaus Mueller-Glaser
(with Bernard Courtois)



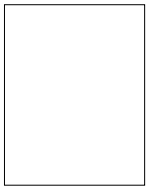
Architectural Synthesis
Fadi Kurdahi



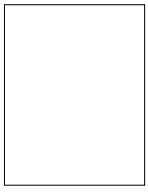
Architectural Synthesis
Ahmed Jerraya



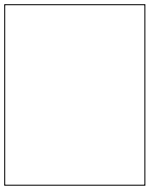
Mixed Signal
Georges Gielen



FSM Synthesis
Michel Berkelaar

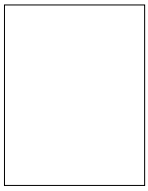


Formal Verification
Carlos Delgado Kloos

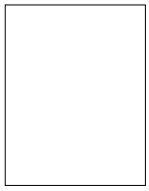


Low Power
Jacques Benkoski
(with Wolfgang Nebel)

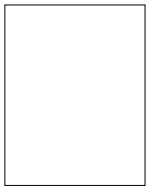
Programme Topic Co-Chairs (continued)



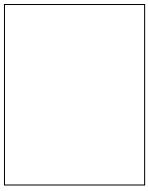
Physical Design
Erich Barke



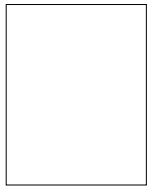
Physical Design
Bernd Schuermann



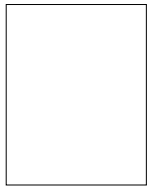
Test Programs
Joan Figueras



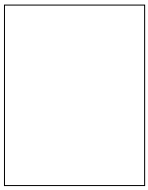
Test Programs
Christian Landrault



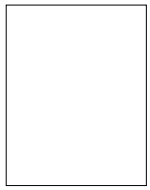
Simulation
Peter Schwarz



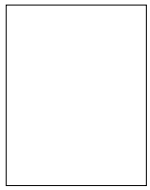
Simulation
John Forrest



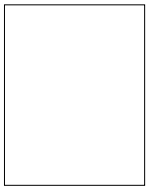
Testability
Einar Aas



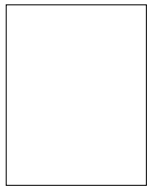
Unit Testing
Rene Segers



HDL Design
Wolfgang Ecker



VHDL
Eugenio Villar



Design Re-Use
Ralf Seepold
(with Jim Heaton)

ASIC & ASIP Design
Yervant Zorian (E)

Vendors Committee

Hanns Windele
Catherine Weiss
Irene McCarty
Mike Northwood
Hans Detlef Boesch
Hein Van Der Wildt
Shubha Shukla

NB Members of more than one committee are only pictured once with indication of other contributions
(E) Event Steering Board (C) Conference Committee (T) Topic Chairs
(P) Technical Programme Panels (V) Vendors Committee